# EMI/RFI SHIELDING LAMINATES

## EM-X700 Series

# **Product Data**

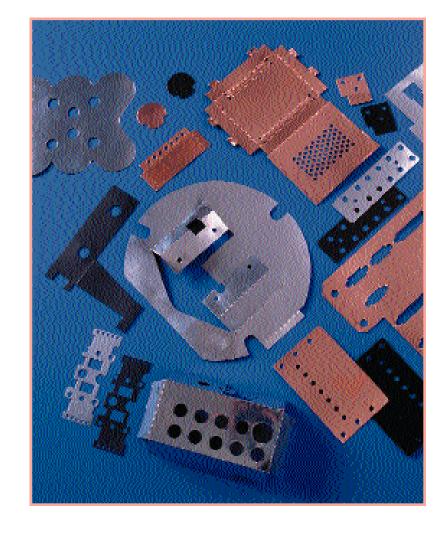
#### **DESCRIPTION:**

ORION's EM-X700 series of high performance EMI/RFI Shielding Laminates offers superior shielding characteristics and excellent formability, while maintaining excellent insulating and dielectric characteristics. The EM-X700 series of materials offers UL 1950 and UL 746 C performance down to a total thickness of 0.014". These materials use G.E. Lexan® FR-700 as their insulating substrate.

available in combinations with a variety of shielding metals. Their excellent dielectric strength and formability make them the ideal choice for a wide range of electrical and electronic applications. Their increased thickness and stiffness provide additional structural integrity to the finished part.

## Potential Applications include:

- PC Board Level Shielding
- Business Equipment Shielding
- Connector Bar Shielding
- Total Enclosure Shielding



- TV/Monitor Shielding
- Keyboard Shielding
- Power Supply Shielding
- Large Dissipation Planes
- Component Wrapping
- Ground Straps

#### **CONFIGURATION:**

Film Color:

Insulating Layer Finish:

Standard Roll Widths:

Standard Gauges (insulating layer):

Available Foils:

Standard Gauges (Foil):

Black
Matte or Polish
up to 48" wide
0.010", 0.017", 0.030"
Aluminum, Copper,
Tin Plated Copper (SnCu)
0.002", 0.005"

ORION holds two patents on EMI shield designs

**Prototypes Within 24 Hours** 



**ORION**'s EM-X700 series of shielding laminates have been tested to the following standards: UL94, UL1950. The table below summarizes our UL listing for this series of materials.

**Component - Insulating Devices and Materials, Miscellaneous** 

ORION INDUSTRIES INCORPORATED
ONE ORION PARK DRIVE, AYER, MASSACHUSETTS 01432

E184188 (R) (B card)

Mtl Dsg Polycarbonal	Col te (PC) - clad	Foil Type aluminum, cop	Foil Thickness per or tin-plated co	Nom Thk (In.) pper .	UL94 Flame* Class	RTI All Properties
EM-1710	BK	Al	0.002	0.014	94V-0	50
EM-2710	BK	Cu	0.002	0.014	94V-0	50
EM-3710	BK	SnCu	0.002	0.014	94V-0	50
EM-4710	BK	Al	0.005	0.017	94V-0	50
EM-5710	BK	Cu	0.005	0.017	94V-0	50
EM-6710	BK	SnCu	0.003	0.015	94V-0	50

Marking: Company name and material designation on container or wrapper.

#### See General Information Preceding These Recognitions.

For use only in equipment where the acceptability of the combination is determined by Underwriters Laboratories Inc.

In addition to the UL listings that our EM series of materials received. Orion Industries Incorporated is proud to state that our facility has been registered by Underwriters Laboratories Inc. to the International Organization for Standardization, ISO 9002 Standard for Quality.

### For additional information, questions, or samples:





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EMI/RFI Shielding Laminates • Insulators • Seals and Gaskets • Screens • Precision Die Cutting • Laminating • Adhesives • Screen Printing/Hot Stamping

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